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Standard Specification for Electrodeposited Coatings of Palladium-Nickel for Engineering Use¹

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1. Scope

1.1 *Composition*—This specification covers requirements for electrodeposited palladium-nickel coatings containing between 70 and 95 mass % of palladium metal. Composite coatings consisting of palladium-nickel and a thin gold overplate for applications involving electrical contacts are also covered.

1.2 *Properties*—Palladium is the lightest and least noble of the platinum group metals. Palladium-nickel is a solid solution alloy of palladium and nickel. Electroplated palladium-nickel alloys have a density between 10 and 11.5, which is substantially less than electroplated gold (17.0 to 19.3) and comparable to electroplated pure palladium (10.5 to 11.8). This yields a greater volume or thickness of coating per unit mass and, consequently, some saving of metal weight. The hardness range of electrodeposited palladium-nickel compares favorably with electroplated noble metals and their alloys **(1, 2)**.²

NOTE 1—Electroplated deposits generally have a lower density than their wrought metal counterparts.

	Approximate Hardness (HK ₂₅)
Gold	50–250
Palladium	75–600
Platinum	150–550
Palladium-Nickel	300–650
Rhodium	750–1100
Ruthenium	600–1300

1.3 The values stated in SI units are to be regarded as the standard. The values given in parentheses are for information only.

1.4 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use.*

1.5 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

2. Referenced Documents

2.1 *ASTM Standards*:³

- [B183 Practice for Preparation of Low-Carbon Steel for Electroplating](#)
- [B242 Guide for Preparation of High-Carbon Steel for Electroplating](#)
- [B254 Practice for Preparation of and Electroplating on Stainless Steel](#)
- [B281 Practice for Preparation of Copper and Copper-Base Alloys for Electroplating and Conversion Coatings](#)
- [B322 Guide for Cleaning Metals Prior to Electroplating](#)
- [B343 Practice for Preparation of Nickel for Electroplating with Nickel](#)
- [B374 Terminology Relating to Electroplating](#)
- [B481 Practice for Preparation of Titanium and Titanium Alloys for Electroplating](#)
- [B482 Practice for Preparation of Tungsten and Tungsten Alloys for Electroplating](#)

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² The boldface numbers in parentheses refer to the list of references at the end of this specification.

³ For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

- B487 Test Method for Measurement of Metal and Oxide Coating Thickness by Microscopical Examination of Cross Section
- B488 Specification for Electrodeposited Coatings of Gold for Engineering Uses
- B489 Practice for Bend Test for Ductility of Electrodeposited and Autocatalytically Deposited Metal Coatings on Metals
- B507 Practice for Design of Articles to Be Electroplated on Racks
- B542 Terminology Relating to Electrical Contacts and Their Use
- B558 Practice for Preparation of Nickel Alloys for Electroplating
- B568 Test Method for Measurement of Coating Thickness by X-Ray Spectrometry
- B571 Practice for Qualitative Adhesion Testing of Metallic Coatings
- B602 Test Method for Attribute Sampling of Metallic and Inorganic Coatings
- B697 Guide for Selection of Sampling Plans for Inspection of Electrodeposited Metallic and Inorganic Coatings
- B741 Test Method for Porosity In Gold Coatings On Metal Substrates By Paper Electrography (Withdrawn 2005)⁴
- B748 Test Method for Measurement of Thickness of Metallic Coatings by Measurement of Cross Section with a Scanning Electron Microscope
- B762 Test Method of Variables Sampling of Metallic and Inorganic Coatings
- B765 Guide for Selection of Porosity and Gross Defect Tests for Electrodeposits and Related Metallic Coatings
- B798 Test Method for Porosity in Gold or Palladium Coatings on Metal Substrates by Gel-Bulk Electrography
- B799 Test Method for Porosity in Gold and Palladium Coatings by Sulfurous Acid/Sulfur-Dioxide Vapor
- B809 Test Method for Porosity in Metallic Coatings by Humid Sulfur Vapor (“Flowers-of-Sulfur”)
- B827 Practice for Conducting Mixed Flowing Gas (MFG) Environmental Tests
- B845 Guide for Mixed Flowing Gas (MFG) Tests for Electrical Contacts
- B849 Specification for Pre-Treatments of Iron or Steel for Reducing Risk of Hydrogen Embrittlement
- B850 Guide for Post-Coating Treatments of Steel for Reducing the Risk of Hydrogen Embrittlement
- D1125 Test Methods for Electrical Conductivity and Resistivity of Water
- D3951 Practice for Commercial Packaging

3. Terminology

3.1 *Definitions:* Many terms used in this specification are defined in Terminology B374 or B542.

3.2 *Definitions of Terms Specific to This Standard:*

3.2.1 *overplating, n*—a coating applied onto the topmost palladium-nickel coating. The thickness of an overplating or “flash” is usually less than 0.25 μm .

3.2.2 *significant surfaces, n*—those surfaces normally visible (directly or by reflection) or which are essential to the serviceability or function of the article; or which can be the source of corrosion products or tarnish films that interfere with the function or desirable appearance of the article. The significant surfaces shall be indicated on the drawings of the parts, or by the provision of suitably marked samples.

3.2.3 *underplating, n*—a metallic coating layer or layers between the basis metal or substrate and the palladium-nickel coating. The thickness of an underplating is usually greater than 1 μm , in contrast to a strike which is thinner.

4. Classification

4.1 Orders for articles to be plated in accordance with this specification shall specify the coating system, indicating the basis metal, the thicknesses of the underplatings, the type and thickness class of the palladium-nickel coating, and the grade of the gold overplating according to Table 1, Table 2, and Table 3. See Section 7.

5. Ordering Information

5.1 In order to make the application of this specification complete, the purchaser shall supply the following information to the seller in the purchase order or other governing document:

5.1.1 The name, designation, and date of issue of this specification;

5.1.2 The coating system including basis metal, composition type, thickness class and gold overplate grade (see 4.1 and Table 1, Table 2, and Table 3);

TABLE 1 Composition Type

Type	Nominal Composition (Mass %)	Range (Mass% Pd)
I	75 % Pd/25 % Ni	70–80 % Pd
II	80 % Pd/20 % Ni	75–85 % Pd
III	85 % Pd/15 % Ni	80–90 % Pd
IV	90 % Pd/10 % Ni	85–95 % Pd

⁴ The last approved version of this historical standard is referenced on www.astm.org.

TABLE 2 Thickness Class^A

Thickness Class	Minimum Thickness of Pd-Ni (μm)
0.4	0.4
0.5	0.5
0.7	0.7
1.0	1.0
1.3	1.3
1.5	1.5
2.0	2.0
2.5	2.5
3.0	3.0

^A See [Appendix X3](#) on Electrical Contact Performance Versus Thickness Class.

TABLE 3 Gold Overplate^A

Grade	Type	MIL-G-45204	Hardness (Code)	Thickness Range
0	No Overplate
1	1 (99.9 % Au min)	III	90 HK ₂₅ max (A)	0.05–0.12 μm
2	2 (99.7 % Au min)	I	130–200 HK ₂₅ (C)	0.05–0.25 μm

^A See Specification [B488](#) and [Appendix X1](#) and [Appendix X2](#).

- 5.1.3 Presence, composition, and thickness of underplating (see [3.2.1](#)). For nickel underplating see [6.5.1](#);
- 5.1.4 Significant surfaces shall be defined (see [3.2.3](#));
- 5.1.5 Requirements, if any, for porosity testing (see [9.6](#));
- 5.1.6 (Steel parts only) Stress relief if required (see Specification [B849](#));
- 5.1.7 (Steel parts only) Hydrogen embrittlement relief (see [B850](#));
- 5.1.8 Sampling plan employed (see Section [8](#)); and,
- 5.1.9 Requirement, if any, for surface coating cleanliness (absence of residual salts). See [Appendix X6](#).

6. Manufacture

6.1 Any process that provides an electrodeposit capable of meeting the specified requirements will be acceptable.

6.2 Substrate:

6.2.1 The surface condition of the basis metal should be specified and should meet this specification prior to the plating of the parts.

6.2.2 Defects in the surface of the basis metal, such as scratches, porosity, pits, inclusions, roll and die marks, laps, cracks, burrs, cold shuts, and roughness may adversely affect the appearance and performance of the deposit, despite the observance of the best plating practice. Any such defects on significant surfaces should be brought to the attention of the supplier and the purchaser.

6.2.3 Clean the basis metal as necessary to ensure a satisfactory surface for subsequent electroplating in accordance with Practices [B183](#), [B242](#), [B254](#), [B281](#), [B322](#), [B343](#), [B481](#), [B482](#), and [B558](#).

6.2.4 Proper preparatory procedures and thorough cleaning of the basis metal are essential for satisfactory adhesion and performance of these coatings. The surface must be chemically clean and continuously conductive, that is, without inclusions or other contaminants. The coatings must be smooth and as free of scratches, gouges, nicks, and similar imperfections as possible.

NOTE 2—A metal finisher can often remove defects through special treatments such as grinding, polishing, abrasive blasting, chemical treatments, and electropolishing. However, these may not be normal in the treatment steps preceding the plating, and a special agreement is indicated.

6.3 If required (see [5.1.6](#)), steel parts with a hardness greater than 1000 MPa (31 HRC) shall be given a suitable stress relief heat treatment prior to plating in accordance with Specification [B849](#). Such stress relief shall not reduce the hardness to a value below the specified minimum. Avoid acid pickling of high strength steels.

6.3.1 Apply the coating after all basis metal preparatory heat treatments and mechanical operations on significant surfaces have been completed.

6.4 Racking:

6.4.1 Position parts to allow free circulation of solution over all surfaces. The location of rack or wire marks in the coating should be agreed upon between the producer and supplier.

6.5 Plating Process:

6.5.1 *Nickel Underplating*—Apply a nickel underplating before the palladium-nickel when the product is made from copper or copper alloy. Nickel underplatings are also applied for other reasons. See [Appendix X5](#).

NOTE 3—In certain instances where high frequency analog signals are employed, such as wave guides, the magnetic properties of nickel may attenuate the signal. Palladium-nickel itself is non-ferromagnetic when the nickel content is less than 14 mass %.

NOTE 4—In applications where forming or flaring operations are to be applied to the plated component, a ductile nickel electrodeposit should be specified.

6.5.2 *Strikes*—Good practice suggests the use of a palladium strike to follow any underplate or substrate (other than silver or platinum) immediately prior to applying the palladium-nickel.

6.5.3 *Plating*—Good practice calls for the work to be electrically connected when entering the palladium-nickel solution.

NOTE 5—Some palladium-nickel electroplating solutions attack copper. This can result in codeposition of copper impurity. The situation is further aggravated when low current densities are utilized. Copper can be removed from solutions by low current density electrolysis (0.1 to 0.3 mA/cm²).

6.5.4 *Gold Overplating*—Apply a thin gold overplating after the palladium-nickel in any application in which palladium-nickel plated electrical connectors are mated together in a contact pair. This process is necessary to preserve the performance of the contact surface. See [Appendix XI](#) for other reasons for using a gold overplate.

NOTE 6—When using Type 1 gold, the thickness of the gold overplate shall not exceed 0.12 μm (5 μin.) due to increased risk of degrading durability and increasing the coefficient of friction.

6.5.5 *Residual Salts*—For rack and barrel plating applications, residual plating salts can be removed from the articles by a clean, hot (50 to 100°C) water rinse. A minimum rinse time of 2.5 min (racks) or 5 min (barrel) is suggested. Best practice calls for a minimum of three dragout rinses and one running rinse with dwell times of 40 s in each station when rack plating and 80 s when barrel plating. Modern high-velocity impingement type rinses can reduce this time to a few seconds. This is particularly useful in automatic reel-to-reel applications where dwell times are significantly reduced. See [Appendix X6](#).

7. Coating Requirements

7.1 *Nature of Coating*—The palladium-nickel deposit shall have a minimum purity of 70 mass % palladium.

7.2 *Composition*—The composition of the palladium-nickel electrodeposit shall be within ±5 mass % of the specified type.

7.3 *Appearance*—Palladium-nickel coatings shall be coherent, continuous, and have a uniform appearance to the extent that the nature of the basis metal and good commercial practices permit.

7.4 *Thickness*—Everywhere on the significant surface (see [5.1](#)), the thickness of the palladium-nickel coating shall be equal to or exceed the specified thickness. The maximum thickness, however, shall not exceed the drawing tolerance.

NOTE 7—The coating thickness requirement of this specification is a minimum requirement, that is, the coating thickness is required to equal or exceed the specified thickness everywhere on the significant surfaces while conforming to all maximum thickness tolerances given in the engineering drawing. Variation in the coating thickness from point to point on a coated article is an inherent characteristic of electroplating processes. The coating thickness at any single point on the significant surface, therefore, will sometimes have to exceed the specified value in order to ensure that the thickness equals or exceeds the specified value at all points. Hence, most average coating thicknesses will be greater than the specified value. How much greater is largely determined by the shape of the article (see [Practice B507](#)) and the characteristics of the plating process. In addition, the average coating thickness on products will vary from article to article within a production lot. If all of the articles in a production lot are to meet the thickness requirement, the average coating thickness for the production lot as a whole will be greater than the average necessary to assure that a single article meets the requirement. See [8.1](#).

7.5 *Adhesion*—The palladium-nickel coatings shall be adherent to the substrate or underplate when tested by one of the procedures summarized in [9.5](#).

7.6 *Integrity of the Coating:*

7.6.1 *Gross Defects/Mechanical Damage*—The coatings shall be free of visible mechanical damage and similar gross defects when viewed at magnifications up to 10×. For some applications this requirement may be relaxed to allow for a small number of such defects (per unit area), especially if they are outside of or on the periphery of the significant surfaces. See [7.6.2](#).

7.6.2 *Porosity*—Almost all as-plated electrodeposits contain some porosity, and the amount of porosity to be expected for any one type of coating will increase with decreasing the thickness of that particular coating type. The amount of porosity in the coating that may be tolerable depends on the severity of the environment that the article is likely to encounter during service or storage. If the pores are few in number, or away from the significant surfaces, their presence can often be tolerated. Acceptance or pass-fail criteria, if required, shall be part of the product specification for the particular article or coating requiring the porosity test. See [9.6](#).

NOTE 8—Extensive reviews of porosity and porosity testing can be found in the literature ([3](#), [4](#)).

8. Sampling

8.1 The purchaser and producer are urged to employ statistical process control in the coating process. Properly performed, statistical process control will assure coated products of satisfactory quality and will reduce the amount of acceptance inspection. The sampling plan used for the inspection of the quality of the coated articles shall be as agreed upon between the purchaser and the supplier.

8.1.1 When a collection of coated articles (the inspection lot (see [8.2](#))) is examined for compliance with the requirements placed on the articles, a relatively small number of the articles (the sample) is selected at random and is inspected. The inspection lot is then classified as complying or not complying with the requirements based on the results of the inspection of the sample. The size

of the sample and the criteria of compliance are determined by the application of statistics. The procedure is known as sampling inspection. Test Method **B602**, Guide **B697**, and Method **B762** contain sampling plans that are designed for the sampling inspection of coatings.

8.1.2 Test Method **B602** contains four sampling plans, three for use with tests that are non-destructive and one when they are destructive. The buyer and seller may agree on the plan or plans to be used. If they do not, Test Method **B602** identifies the plan to be used.

8.1.3 Guide **B697** provides a large number of plans and also gives guidance in the selection of a plan. When Guide **B697** is specified, the buyer and seller need to agree on the plan to be used.

8.1.4 Method **B762** can be used only for coating requirements that have a numerical limit, such as coating thickness. The test must yield a numerical value and certain statistical requirements must be met. Method **B762** contains several plans and also gives instructions for calculating plans to meet special needs. The buyer and the seller may agree on the plan or plans to be used. If they do not, Method **B762** identifies the plan to be used.

8.2 An inspection lot shall be defined as a collection of coated articles that are of the same kind, that have been produced to the same specifications, coated by a single supplier at one time, or at approximately the same time, under essentially identical conditions, and that are submitted for acceptance or rejection as a group.

9. Test Methods

9.1 *Appearance*—The coating shall be examined at up to 10× magnification for conformance to the requirements of appearance.

9.2 *Alloy Composition*—Alloy composition of the palladium-nickel can be determined by a wet method, X-ray Fluorescence (XRF), Scanning Electron Microscopy (SEM)/Energy Dispersive Spectroscopy (EDS), Auger, or by Electron Probe X-ray Microanalysis (EPMA)/Wavelength Dispersive Spectroscopy (WDS).

9.2.1 The method chosen for determination of alloy composition shall not be the same method used for determination of deposit thickness if the deposit is over a nickel underplate or as a referee method. The reason for this is that the determination of alloy composition and the determination of deposit thickness by spectrographic analysis are to some extent interdependent. See **9.2.4.1** and **9.4.1**.

9.2.2 *Wet Method*—Use any recognized method to determine quantitatively the relative concentrations of palladium and nickel present. Atomic absorption spectrophotometry (or any other methods with demonstrated uncertainty less than 10 %) may be used to determine the alloy composition.

NOTE 9—Determination of alloy composition by dissolving the coating from a test specimen must be obtained by electroplating the palladium-nickel directly over a non-nickel containing alloy substrate with no intermediate layer. Copper alloy substrates are preferred. Alloy composition is best determined on a special test specimen. One must be careful to arrange the specimen so as to electroplate at a typical current density, similar to what is used in production. Palladium-nickel may be stripped by utilizing a 90 volume % (reagent grade) sulfuric acid, 10 volume % (reagent grade) nitric acid solution.

9.2.3 *XRF*—XRF can be used for composition analysis of palladium-nickel alloy coatings deposited directly onto copper or a copper alloy that does not contain nickel. This method is not suitable for composition analysis of palladium-nickel alloy coatings less than 60 μm in thickness when deposited over nickel or nickel containing substrates.

NOTE 10—If the palladium-nickel coating is less than 60 μm, palladium-nickel alloy composition measurements in the presence of an intermediate nickel layer or nickel containing substrate is degraded by the fact that the nickel X-ray emission of the alloy layer and the intermediate layer (or substrate) cannot be accurately distinguished from one another.

9.2.4 *EPMA*:

9.2.4.1 EPMA based on electron beam excitation of X-rays characteristic of the elements present can be used to measure composition of palladium-nickel alloy coatings on top of any undercoat or any substrate to an accuracy of 0.1 mass % palladium if the thickness of the coating is ≥1.5 μm. See **Appendix X8**.

9.2.4.2 EPMA shall be used as the referee method for the determination of alloy composition.

9.2.5 *SEM/EDS*—The SEM/EDS technique is capable of determining composition of palladium-nickel coatings that are ≥1.5 μm thick to an accuracy and precision of ±0.2 mass % palladium. A procedure for calibration of a conventional SEM equipped with an X-ray EDS for routine analysis of palladium-nickel alloy coating composition appears in **Appendix X7**.

9.2.6 *Auger Electron Spectroscopy (AES) and X-ray Photoelectron Spectroscopy (XPS)*—AES and XPS are capable of analyzing regions that are of the order of 0.002 μm thick. These techniques are potential candidates for analysis of electrodeposited palladium-nickel alloy coatings with a thickness of ≥0.03 μm.

NOTE 11—The use of AES and XPS to determine bulk coating composition requires the sputter removal of 0.01 to 0.02 μm of material from the surface to remove surface contaminants and surface composition gradients. Some, but not all, commercial AES and XPS instruments are capable of accurate analyses of palladium-nickel alloy composition using an internal procedure for determining correction factors similar to that described in **Appendix X7** for an SEM/EDS instrument.

9.3 *Deposit Purity*—Use any recognized method to determine quantitatively the metallic impurities present. Atomic absorption spectrophotometry (or any other methods with demonstrated uncertainty less than 10 %) may be used to determine the metallic

impurities. Initial scanning should be carried out for all elements, in order to detect any unknown or unexpected impurities. Determine deposit purity by subtracting total impurities from 100 %.

NOTE 12—Deposit purity is best determined on a special test specimen. One shall be careful to arrange the specimen so as to electroplate at a typical current density, similar to what is used in production. Palladium-nickel may be stripped by utilizing a 90 volume % (reagent grade) sulfuric acid, 10 volume % (reagent grade) nitric acid solution. The test specimen substrate should be platinum, gold, or an electrodeposit not attacked by the strip solution. For the determination of impurities, the total palladium-nickel deposit should be over 100 mg and the sample weight is determined by a weigh-strip-weigh procedure. The strip solution is then used for quantitative analysis of impurities.

9.4 Thickness:

9.4.1 Measure thickness by methods outlined in Test Methods **B487**, **B568**, or **B748**, or any other test method that has an uncertainty less than 10 %. See **Appendix X2** for specific information on thickness measurement of palladium-nickel alloy coatings by XRF.

9.4.2 Use Test Method **B748** as the referee method for the determination of deposit thickness.

9.5 Adhesion—Determine adhesion by one of the following procedures (see Test Methods **B571** for full details):

9.5.1 *Bend Test*—Bend the electroplated article repeatedly through an angle of 180° on a diameter equal to the thickness of the article until fracture of the basis metal occurs. Examine the fracture at a magnification of 10×. Cracking without separation does not indicate poor adhesion unless the coating can be peeled back with a sharp instrument.

9.5.2 *Heat Test*—No flaking, blistering, or peeling shall be apparent at a magnification of 10× after the palladium-nickel electroplated parts are heated to 300 to 350°C (570 to 660°F) for 30 min and allowed to air cool.

9.5.3 *Cutting Test*—Make a cut with a sharp instrument and then probe with a sharp point and examine at a magnification of 10×. No separation of the coating from the substrate or intermediate layers shall occur.

9.6 *Plating Integrity*—Porosity and microcracks shall be determined by either Test Methods **B741**, **B798**, **B799**, or **B809** unless otherwise specified. Do not use the nitric acid vapor test (palladium-nickel can dissolve in nitric acid).

NOTE 13—The test to be selected will depend on the palladium-nickel thickness, the nature of the basis metal, the nature and thickness of any intermediate layers or underplate, and the shape of the palladium-nickel plated part. Guide **B765** is suitable to assist in the selection of porosity tests for electrodeposits of palladium-nickel alloys.

9.7 *Ductility*—When required, determine ductility in accordance with Practice **B489**.

10. Special Government Requirements

10.1 The following special requirements shall apply when the ultimate purchaser is the federal government or an agent of the federal government.

10.1.1 *Sampling*—For government acceptance, the sampling plan specified in MIL-STD-105 is to be used instead of the ASTM standards specified in **8.1**.

10.1.2 *Thickness Testing*:

10.1.2.1 In addition to the nondestructive methods outlined in Test Method **B568**, a cross-sectioning method, such as that specified by Test Methods **B487** or **B748**, shall be used as a referee method to confirm the precision and bias of the particular nondestructive technique that is used.

10.1.2.2 The palladium-nickel thickness on significant surfaces shall be at least 1.3 μm (50 μin.), unless otherwise specified on the drawings or in the contract. The coating on nonsignificant surfaces shall be of sufficient thickness to ensure plating continuity and uniform utility, appearance, and protection. The thickness of plating on nonsignificant surfaces, unless specifically exempted, shall be a minimum of 60 % of that specified for significant surfaces.

10.1.3 *Packaging*—The packaging and packing requirements shall be in accordance with Practice **D3951** or as specified in the contract or order.

APPENDIXES

(Nonmandatory Information)

X1. SOME REASONS FOR USING A GOLD OVERPLATE

X1.1 A gold overplate is employed to enhance the performance of the palladium-nickel surface. Two types of gold are used:

X1.1.1 Type 1 gold is used in the critical areas in thickness ranges of 0.05 to 0.12 μm.

X1.1.2 Type 2 gold is used in the critical areas in thickness ranges of 0.05 to 0.25 μm or higher.